

# APPROVAL SHEET

RFBPF Series – 1608(0603)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

**Halogens Free Product** 

2.4 GHz ISM Band Working Frequency

P/N: RFBPF1608060ABT

\*Contents in this sheet are subject to change without prior notice.

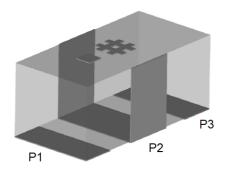
#### **FEATURES**

- 1. Miniature footprint: 1.6 X 0.8 X 0.6 mm<sup>3</sup>
- 2. Low Profile Thickness
- 3. Low Insertion loss
- 4. High Rejection Rate
- 5. High attenuation on 2<sup>nd</sup> harmonic suppressed
- 6. LTCC process

# **APPLICATIONS**

- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g, HomeRF

# CONSTRUCTION



PIN	Connection			
1	Input port			
2	GND			
3	Output port			

#### **DIMENSIONS**

Figure	Symbol	Dimension (mm)
C D E	L	1.60 ± 0.15
	W	0.80 ± 0.15
	Т	0.60 ± 0.10
	А	0.55 ± 0.15
	В	0.50 ± 0.15
	С	0.35 ± 0.15
	D	0.50 ± 0.15
	E	0.20 ± 0.15



# **ELECTRICAL CHARACTERISTICS**

RFBPF1608060ABT	Specification
Frequency range	2450 ± 50 MHz
Incoming Lond	2.5 dB max at +25°C
Insertion Loss	2.8 dB max at -40°C ~ +85°C
VSWR	2.0 max
Impedance	50 Ω
	38 dB @ 880 - 915 MHz
	40 dB @ 1710 - 1850 MHz
	40 dB @ 1850 - 1910 MHz
Attenuation (min.)	35 dB @ 1920 - 1990 MHz
	25 dB @ 2170 MHz
	30 dB @ 4800 - 5000 MHz
	20 dB @ 7200 - 7500 MHz
Operation Temperature Range	-40°C ~ +85°C
Typical Electrical Chart	
-10 -20 -30	

# **SOLDER LAND PATTERN**

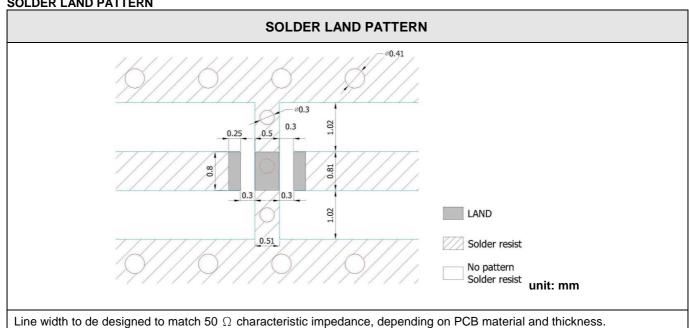
-40

-50

-60 0.5

1.5

2.5



3.5

4.5

5.5

6.5

7.5

D1 and D2 are the grounding through holes.



# **RELIABILITY TEST**

Test item	Test condition / Test method	Specification	
Solderability JIS C 0050-4.6	*Solder bath temperature : 235 ± 5°C	At least 95% of a surface of each terminal	
JESD22-B102D	*Immersion time : $2 \pm 0.5$ sec	electrode must be covered by fresh solder.	
	Solder : Sn3Ag0.5Cu for lead-free		
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5^{\circ}\text{C}$ *Leaching immersion time : $30 \pm 0.5 \text{ sec}$ Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.	
Resistance to soldering heat			
JIS C 0050-5.4	*Preheating temperature : 120~150°C,	No mechanical damage.	
	1 minute.	Samples shall satisfy electrical specification	
	*Solder temperature: 270±5°C	after test.	
	*Immersion time: 10±1 sec	Loss of metallization on the edges of each	
	Solder: Sn3Ag0.5Cu for lead-free	electrode shall not exceed 25%.	
	Measurement to be made after keeping at		
	room temperature for 24±2 hrs		
Drop Test	*Height: 75 cm	No mechanical damage.	
JIS C 0044 Customer's specification.	*Test Surface : Rigid surface of concrete or steel.	Samples shall satisfy electrical specification after test.	
	*Times: 6 surfaces for each units; 2 times for each side.		
Adhesive Strength	*Pressurizing force :	No remarkable damage or removal of the	
of Termination  JIS C 0051- 7.4.3	5N(≦0603) ; 10N(>0603)	termination.	
	*Test time: 10±1 sec		
Bending test	The middle part of substrate shall be	No mechanical damage.	
JIS C 0051- 7.4.1	pressurized by means of the pressurizing	Samples shall satisfy electrical specification	
	rod at a rate of about 1 mm/s per second	after test.	
	until the deflection becomes 1mm/s and		
	then pressure shall be maintained for 5±1		
	Sec.  Measurement to be made after keeping at		
	room temperature for 24±2 hours		

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Temperature cycle JIS C 0025	<ol> <li>30±3 minutes at -40°C±3°C,</li> <li>10~15 minutes at room temperature,</li> <li>30±3 minutes at +85°C±3°C,</li> <li>10~15 minutes at room temperature,</li> <li>Total 100 continuous cycles</li> <li>Measurement to be made after keeping at room temperature for 24±2 hrs</li> </ol>	No mechanical damage. Samples shall satisfy electrical specification after test.
Vibration JIS C 0040	*Frequency: 10Hz~55Hz~10Hz(1min)  *Total amplitude: 1.5mm  *Test times: 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage.  Samples shall satisfy electrical specification after test.
High temperature JIS C 0021	*Temperature: 85°C±2°C  *Test duration: 1000+24/-0 hours  Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage.  Samples shall satisfy electrical specification after test.
Humidity (steady conditions) JIS C 0022	*Humidity: 90% to 95% R.H.  *Temperature: 40±2°C  *Time: 1000+24/-0 hrs.  Measurement to be made after keeping at room temperature for 24±2 hrs  % 500hrs measuring the first data then 1000hrs data	No mechanical damage.  Samples shall satisfy electrical specification after test.
Low temperature JIS C 0020	*Temperature : -40°C±2°C  *Test duration : 1000+24/-0 hours  Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage.  Samples shall satisfy electrical specification after test.



# **SOLDERING CONDITION**

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

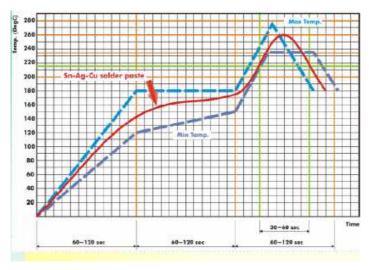


Fig 2. Infrared soldering profile

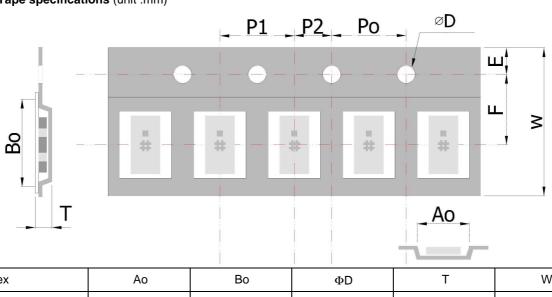
# **ORDERING CODE**

RF	BPF	160806	0	Α	В	Т
Walsin	Product Code	Dimension code	Unit of	Application	Specification	Packing
RF device	BPF:	Per 2 digits of	dimension	A: 2.4GHZ ISM	dependent on	T : Reeled
	Band Pass Filter	Length, Width,	0 : 0.1 mm	Band	different electrical	
		Thickness :	1 : 1.0 mm		specification	
		e.g. :				
		160806 =				
		Length 16,				
		Width 08,				
		Thickness06				

Minimum Ordering Quantity: 4000 pcs per reel.

# **PACKAGING**

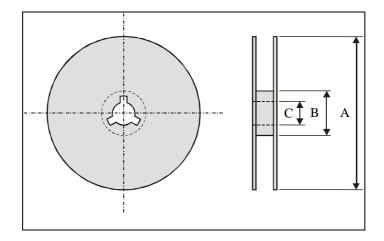
Paper Tape specifications (unit :mm)



Index	Ao	Во	ΦD	Т	W
Dimension (mm)	$0.975 \pm 0.05$	$1.76\pm0.05$	1.55 + 0.05	$0.75 \pm 0.03$	$8.0 \pm 0.10$
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	$3.50\pm0.05$	$4.00 \pm 0.10$	4.00 ± 0.10	$2.00 \pm 0.05$



#### **Reel dimensions**



Index	А	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity: 4000 pieces per 7" reel

#### **CAUTION OF HANDLING**

#### **Limitation of Applications**

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

#### Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40 $^{\circ}$ C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.